## What is claimed is:

- A multi-finger type ESD protection device comprising:
  - a semiconductor substrate;
- a plurality of first active regions formed separately on the semiconductor substrate; and
- a pair of gates formed in each of the first active regions.
  - 2. The device of claim 1, further comprising:
- at least one second active region of a predetermined to conductive type formed additionally between the first active regions.
  - 3. The device of claim 2, wherein the second active region includes an n+ junction connected to Vcc.

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- - 5. The device of claim 2, further comprising:
- a plurality of drain regions formed in each of the first active regions.
  - 6. The device of claim 5, wherein the drain regions include a pair of drain regions formed at n+ junctions of both end portions of each of the first active regions.
    - 7. The device of claim 1, further comprising:
  - a plurality of source regions each formed between the pair of gates in each of the first active regions.
- 8. The device of claim 2, wherein the first and second active regions and the gates extend substantially parallel to each other.

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- second active regions and the gates have a substantially same shape.
  - 10. The device of claim 2, further comprising:
- a third active region surrounding the first and second active regions.
- 11. A multi-finger type ESD protection device comprising:
  - a semiconductor substrate;
- a plurality of first active regions formed separately on the semiconductor substrate;
- a plurality of gates formed in each of the first active regions; and
  - at least one predetermined conductive type second active region each formed between two of the first active regions.

- $\cdot$  . 12. The device of claim 11, wherein the predetermined conductive type second active region is an n+ junction connected to Vcc.
- 13. The device of claim 11, wherein the predetermined 5 conductive type second active region is a p+ junction connected to Vss.
  - 14. The device of claim 11, further comprising:

    drain regions formed at n+ junctions of both end
    portions of the first active regions.
- 10 15. The device of claim 11, further comprising: source regions each formed between two gates in each of the first active regions.
- 16. The device of claim 11, wherein the first and second active regions and the gates extend substantially parallel to each other and have a substantially same shape.

- 17. The device of claim 11, further comprising:
- a third active region surrounding the first and second active regions.
- 18. A multi-finger type ESD protection device comprising:
  - a semiconductor substrate;
- a plurality of first active regions formed separately on the semiconductor substrate;
- a pair of gates formed in each of the first active regions;

drain regions formed at n+ junctions of both end portions of the first active regions;

source regions each formed between the pair of gates in each of the first active regions; and

at least one second active region of a predetermined conductive type, formed between the first active regions.

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- . . . 19. The device of claim 18, wherein the predetermined conductive type second active region includes an n+junction connected to Vcc.
- 20. The device of claim 18, wherein the predetermined conductive type second active region includes a ptunction connected to Vss.